



- NOTE 1. CONNECTOR TO COMPLY WITH PCMCIA PC CARD STANDARD RELEASE '95
2. CONTACT PLATING
 CONTACT AREA: Au 0.1μm MIN. OVER Pd 0.5μm MIN.
 TERMINAL AREA: 9/1 TIN/LEAD 1.5μm MIN.
 ALLOVER: Ni 1μm MIN.
- △ 3. SHIELD PLATE PLATING
 DIMPLE AREA: Au 0.1μm MIN. OVER Pd 0.5μm MIN.
 TERMINAL AREA: 9/1 TIN/LEAD 1.5μm MIN.
 ALLOVER: Ni 1μm MIN.
4. TERMINAL LEAD COPLANARITY IS 0.1MAX.

HONDA
 PRINT RM
 FEB. 3. 2000
 ISSUED

ICMB-68FYGC-OM09	0.9
ICMB-68FYGC-OM06	0.6
ICMB-68FYGC-OM03	0.3
*ICMB-68FYGC-OM02	0.2
ICMB-68FYGC-OM00	0
P/N	DIMENSION A

△ *: THIER CONFIGURATIONS ARE IN THE PLANING STAGE

LTR.	DATE	BY	REV.	DESCRIPT	NO.	PART NAME	MATERIAL	QTY	FINISH	NOTE
△	DEC.16 1999	K.Y		CHANGE TOLERANCE						
△	MAR.5 1999	K.Y		ADD. DIM.P/N CHANGE TOLERANCE						
△	APR.7 1998	K.Y		ADD. OFF SET 0.2mm	3	SHIELD PLATE	PHOSPHOR BRONZE			REFER TO NOTE 3
△	FEB.19 1998	K.Y		CHANGE INSULATOR SHAPE	2	CONTACT	PHOSPHOR BRONZE	68		REFER TO NOTE 2
△	FEB.27 1997	K.Y		CHANGE SHIELD PLATE PLATING	1	INSULATOR	LCP(GF)	1		UL94V-0 BLACK

DATE	SCALE	UNIT	3RD . A . P	HONDA TSUSHIN KOGYO., LTD.						
NOV.25(1996)	2 / 1	mm(INCH)		DR	DE	CHK	CHK	APP	NAME	68 POS. SOCKET CONNECTOR FOR CARD BUS PC CARD
									PART NO.	ICMB-68FYGC-OM()
									REV.	5E